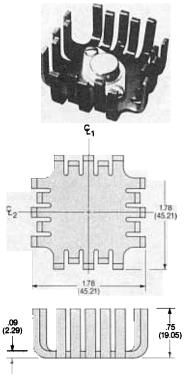
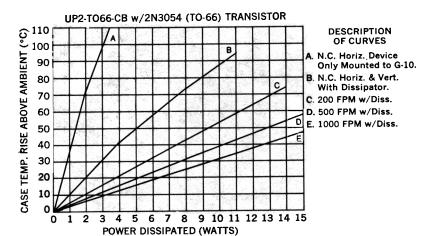


### **UP2 Series** for TO-66 Outline



Dimensions are for reference use only. Contact IERC for dimensions with tolerances or standard part drawings.



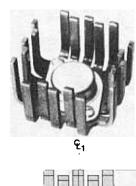
- Thermal Resistance Case to Sink is 0.5-0.7 °C/W w/Joint Compound.
- Derate 0.8 °C/watt for unplated part in natural convection only.
   Derate 0.8 °C/watt for Insulube® part in natural convection only.

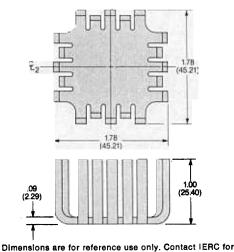
## **Ordering Information**

IERC PART NO.					Hole patt.	Max.
Unplated	Comm'l. Black Anodize	Mil. Black Anodize	Insulube® 448	Semiconductor Accommodated	ref. no. (see pg. 1-29)	Weight (Grams)
UP2-T066-U	UP2-T066-CB	UP2-T066-B	UP2-T066	TO-66	24	19.1
UP2-T066-47U	UP2-T066-47CB	UP2-T066-47B	UP2-T066-47	TO-66 IC	25	19.1
UP2-T066-52U	UP2-T066-52CB	UP2-T066-52B	UP2-T066-52	TO-66 IC (Socket)	26	19.1

Note: See page iv for other finishes.

### **UP Series for TO-3 and Stud Mount Outlines**





dimensions with tolerances or standard part drawings.

ordering Information  IERC PART NO.					Hole	
Unplated	Comm'l. Black Anodize	Mil. Black Anodize	Insulube® 448	Semiconductor Accommodated n	patt. ref. no. (see pg. 1-28)	Max. Weight (Grams)
UP-000-U	UP-000-CB	UP-000-B	UP-000	Undrilled	_	22.5
UP-T03-U	UP-TO3-CB	UP-TO3-B	UP-TO3	T0-3	16	22.5
UP-T03-46U	UP-T03-46CB	UP-T03-46B	UP-T03-46	TO-3 IC	17	22.5
UP-436-U	UP-436-CB	UP-436-B	UP-436	TO-3 (4-pin)	18	22.5
UP-TO6-U	UP-TO6-CB	UP-T06-B	UP-T06	TO-6, TO-36	19	22.5
UP-T015-U	UP-TO15-CB	UP-T015-B	UP-T015	TO-15, DO-5	23	22.5
UP-420-U	UP-420-CB	UP-420-B	UP-420	Universal	27	22.5
UP-TOV-7U	UP-TOV-7CB	UP-TOV-7B	UP-TOV-7	Universal	28	22.5

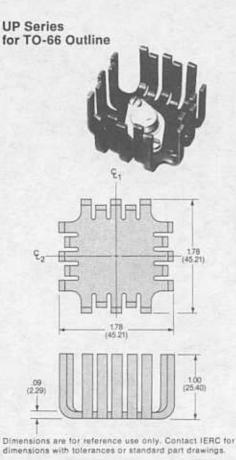
Note: See page iv for other finishes.

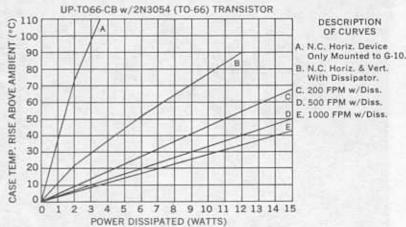
## UP-TO3-CB w/2N3055 (TO-3) TRANSISTOR DESCRIPTION OF CURVES A. N.C. Horiz. Device Only Mounted to G-10. B. N.C. Horiz. & Vert. With Dissipator. C. 200 FPM w/Diss. D. 500 FPM w/Diss. E. 1000 FPM w/Diss.

POWER DISSIPATED (WATTS) Thermal Resistance Case to Sink is 0.1-0.3 °C/W w/Joint Compound.
 Derate 0.8 °C/watt for unplated part in natural convection only.
 Derate 0.4 °C/watt for Insulube® part in natural convection only.

8 10 12 14 16 18 20 22 24 26 28 30

# HEAT DISSIPATORS FOR METAL CASE, CASE-MOUNTED SEMICONDUCTORS





- Thermal Resistance Case to Sink is 0.5-0.7 °C/W w/Joint Compound.
- Derate 0.8 °C/watt for unplated part in natural convection only.
   Derate 0.8 °C/watt for insulube\* part in natural convection only.

### Ordering Information

IERC PART NO.				man and a supplier	Hole patt.	Max.
Unplated	Comm'l. Black Anodize	Mil. Black Anodize	Insulobe® 448	Semiconductor Accommodated	ref. no. (see pg. 1-29)	Weight (Grams)
UP-T066-U	UP-T066-CB	UP-T066-B	UP-T066	TO-66	24	22.5
UP-T066-47U	UP-T066-47CB	UP-T066-47B	UP-T066-47	TO-66 IC	25	22.5
UP-T066-52U	UP-T066-5208	UP-T066-528	UP-T066-52	TO-66 IC (Socket)	26	22.5

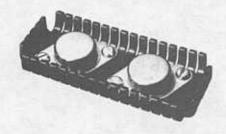
DESCRIPTION OF CURVES

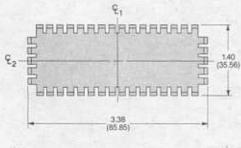
Only Mounted to G-10.

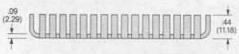
With Dissipator.

Note: See page iv for other finishes.

## UP10 Series for TO-3 **Dual Mount Applications**

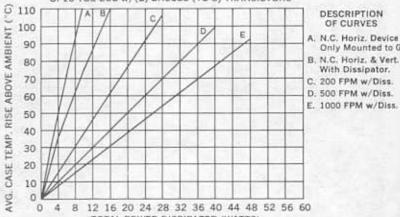






Dimensions are for reference use only. Contact IERC for dimensions with tolerances or standard part drawings

### UP10-T03-2CB w/(2) 2N3055 (TO-3) TRANSISTORS



12 16 20 24 28 32 36 40 44 48 52 56 60 TOTAL POWER DISSIPATED (WATTS) 6 8 10 12 14 16 18 20 22 24 26 28 30

- AVERAGE POWER DISSIPATED PER DEVICE (WATTS) . Thermal Resistance Case to Sink is 0.1-0.3 "C/W w/Joint Compound.
- Derate 0.8 "C/watt per device for unplated part in natural convection only.
   Derate 0.4 "C/watt per device for Insulube" part in natural convection only.
   Case Temperatures Match Within 2 "C at equivalent power levels.

Ordering Information  IERC PART NO.					Hole	
Unplated	Comm'l. Black Anodize	Mil. Black Anodize	Insulube* 448	Semiconductor Accommodated	patt. ref. no. (see pg. 1-29)	Max. Weight (Grams)
UP10-T03-2U UP10-426-2U UP10-428-2U	UP10-T03-2CB UP10-426-2CB UP10-428-2CB	UP10-T03-28 UP10-426-2B UP10-428-2B	UP10-T03-2 UP10-426-2 UP10-428-2	Two TO-3s Universal Two TO-3 (4-pin)	29 30 36	24.0 24.0 24.0

Note: See page ly for other finishes.